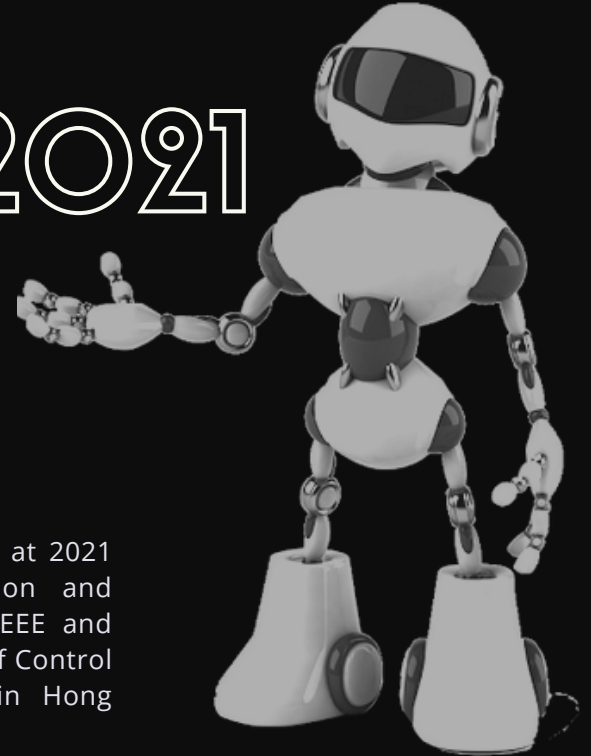


# IEEE-RAAI 2021

HONG KONG  
APRIL 21-23, 2021

## WELCOME TO RAAI

The Conference Committee warmly invites you to join us at 2021 IEEE International Conference on Robotics, Automation and Artificial Intelligence (RAAI 2021), which sponsored by IEEE and CEDA Hong Kong chapter, and hosted by Beijing Institute of Control Robotics and Intelligent Technology. It will be held in Hong Kong during April 21-23, 2021.



## CALL FOR PAPERS

**Topics of interest for submission include, but are not limited to:**

- Artificial muscle actuators
- Autonomous control of unmanned vehicles
- Mobile robotics
- Pattern and object recognition and tracking
- Robotics manipulation
- Modeling of power semiconductors
- Machine learning and deep learning
- Variable structure control

**More topics:** <http://www.raai.net/cfp.html>

## SUBMISSION GUIDELINE

### 1: Submission ([Online Submission System](#))

An academic paper should be in MSWord file, at least 4 full pages

### 2: Confirmation & Reviewing process

A confirmation and paper id for submission will be sent via email within 1-2 working days. Then, your paper will go through a preliminary review process and a peer review process

### 3: Notification of Acceptance

Please complete registration only after you receive the notification of acceptance.

**More details:** <http://www.raai.net/sub.html>

## PUBLICATION

All full paper submissions will be peer reviewed and evaluated based on originality, technical and/or research content/depth, correctness, relevance to conference, contributions, and readability. Accepted papers will be published into **RAAI 2021 Conference Proceedings**.

## IMPORTANT DATES

Paper Submission Deadline:

- **November 20th, 2020**

Notification of Acceptance:

- December 20th, 2020

## GET IN TOUCH

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